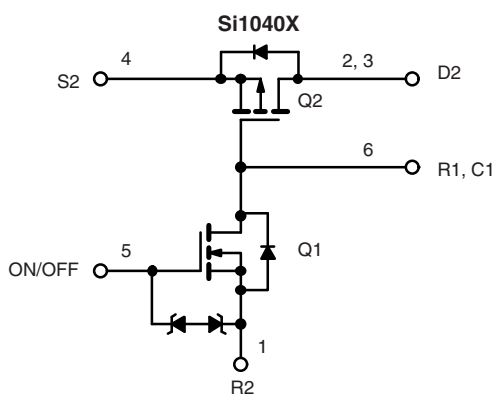


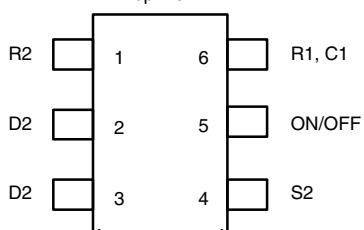
Load Switch with Level-Shift

PRODUCT SUMMARY

V_{DS2} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
1.8 to 8	0.625 at $V_{IN} = 4.5$ V	± 0.43
	0.890 at $V_{IN} = 2.5$ V	± 0.36
	1.25 at $V_{IN} = 1.8$ V	± 0.3

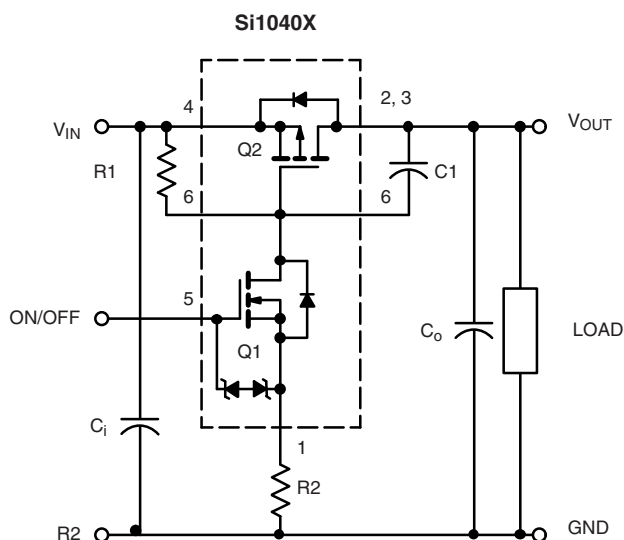


SC89-6
Top View



Ordering Information: Si1040X-T1-GE3 (Lead (Pb)-free and Halogen-free)

TYPICAL APPLICATION CIRCUIT



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 1.8 V to 8 V Input
- 1.5 V to 8 V Logic Level Control
- Smallest LITTLE FOOT® Package: 1.6 mm x 1.6 mm
- 2000 V ESD Protection On Input Switch, $V_{ON/OFF}$
- Adjustable Slew-Rate
- Compliant to RoHS Directive 2002/95/EC

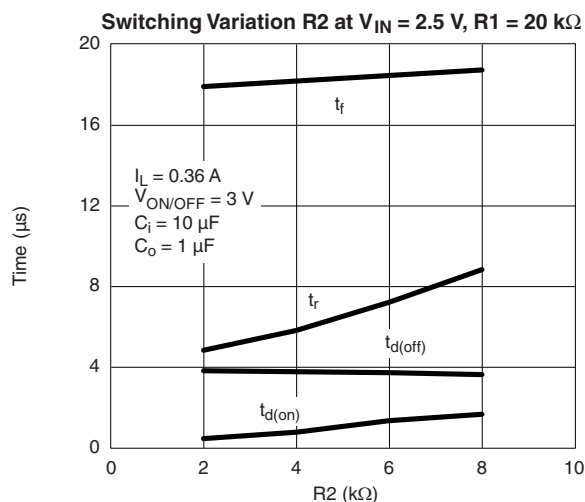
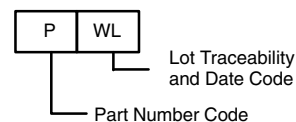


RoHS
COMPLIANT
HALOGEN
FREE

DESCRIPTION

The Si1040X includes a p- and n-Channel MOSFET in a single SC89-6 package. The low on-resistance p-channel TrenchFET is tailored for use as a load switch. The n-channel, with an external resistor, can be used as a level-shift to drive the p-channel load-switch. The n-channel MOSFET has internal ESD protection and can be driven by logic signals as low as 1.5 V. The Si1040X operates on supply lines from 1.8 V to 8 V, and can drive loads up to 0.43 A.

Marking Code



Note: For R2 switching variations with other $V_{IN}/R1$ combinations See Typical Characteristics

COMPONENTS

R1	Pull-Up Resistor	Typical 10 k Ω to 1 m Ω ^a
R2	Optional Slew-Rate Control	Typical 0 to 100 k Ω ^a
C1	Optional Slew-Rate Control	Typical 1000 pF

Notes:

a. Minimum R1 value should be at least 10 x R2 to ensure Q1 turn-on.

The Si1040X is ideally suited for high-side load switching in portable applications. The integrated N-Channel level-shift device saves space by reducing external components. The slew rate is set externally so that rise-times can be tailored to different load types.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Limit	Unit
Input Voltage	V_{IN}	8	V
ON/OFF Voltage	$V_{ON/OFF}$	8	
Load Current	Continuous ^{a, b}	± 0.43	A
	Pulsed ^{b, c}	± 1.0	
Continuous Intrinsic Diode Conduction ^a	I_S	- 0.15	
Maximum Power Dissipation ^a	P_D	0.174	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150	$^\circ\text{C}$
ESD Rating, MIL-STD-883D Human Body Model (100 pF, 1500 Ω)	ESD	2	kV

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient (Continuous Current) ^a	R_{thJA}	600	720	$^\circ\text{C/W}$
Maximum Junction-to-Foot (Q2)	R_{thJC}	450	540	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
OFF Characteristics						
Reverse Leakage Current	I_{FL}	$V_{IN} = 8\text{ V}, V_{ON/OFF} = 0\text{ V}$			1	μA
Diode Forward Voltage	V_{SD}	$I_S = - 0.15\text{ A}$		0.85	1.2	V
ON Characteristics						
Input Voltage Range	V_{IN}		1.8		8	V
On-Resistance (P-Channel) at 1 A	$R_{DS(on)}$	$V_{ON/OFF} = 1.5\text{ V}, V_{IN} = 4.5\text{ V}, I_D = 0.43\text{ A}$		0.500	0.625	Ω
		$V_{ON/OFF} = 1.5\text{ V}, V_{IN} = 2.5\text{ V}, I_D = 0.36\text{ A}$		0.710	0.890	
		$V_{ON/OFF} = 1.5\text{ V}, V_{IN} = 1.8\text{ V}, I_D = 0.3\text{ A}$		1.0	1.25	
On-State (P-Channel) Drain Current	$I_{D(on)}$	$V_{IN-OUT} \leq 0.2\text{ V}, V_{IN} = 5\text{ V}, V_{ON/OFF} = 1.5\text{ V}$	1			A
		$V_{IN-OUT} \leq 0.3\text{ V}, V_{IN} = 3\text{ V}, V_{ON/OFF} = 1.5\text{ V}$	0.8			

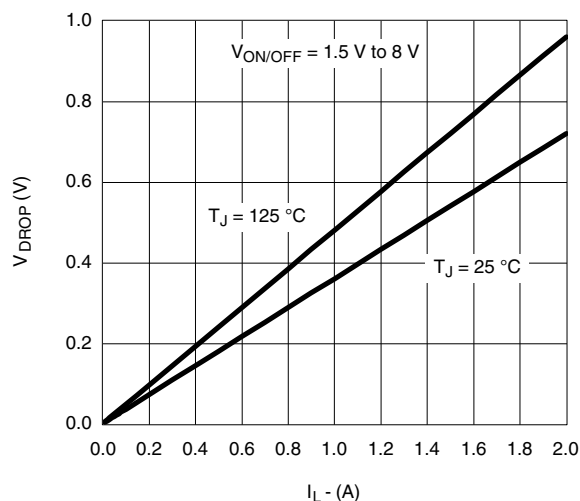
Notes:

a. Surface mounted on FR4 board.

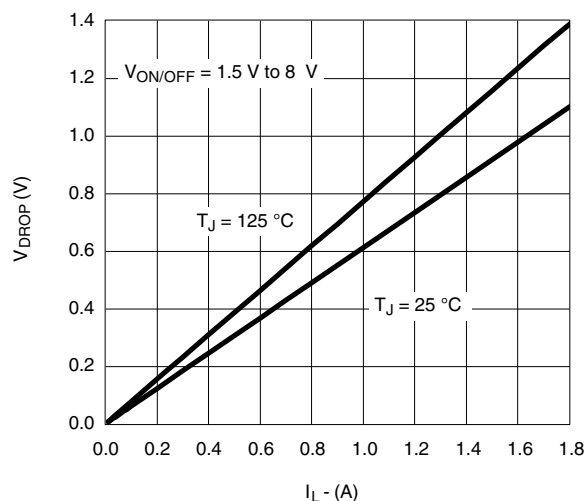
b. $V_{IN} = 8\text{ V}, V_{ON/OFF} = 8\text{ V}, T_A = 25^\circ\text{C}$.c. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

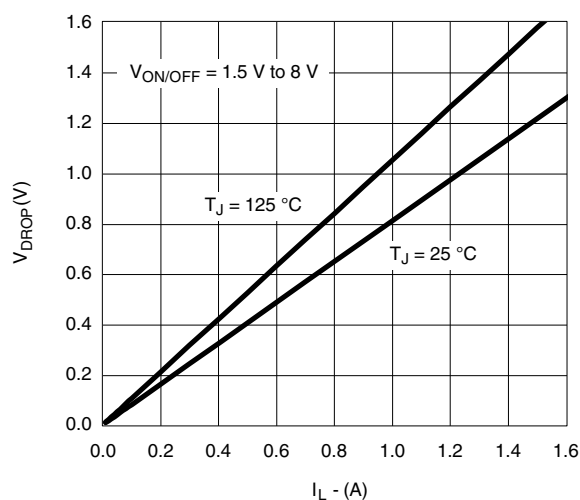
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



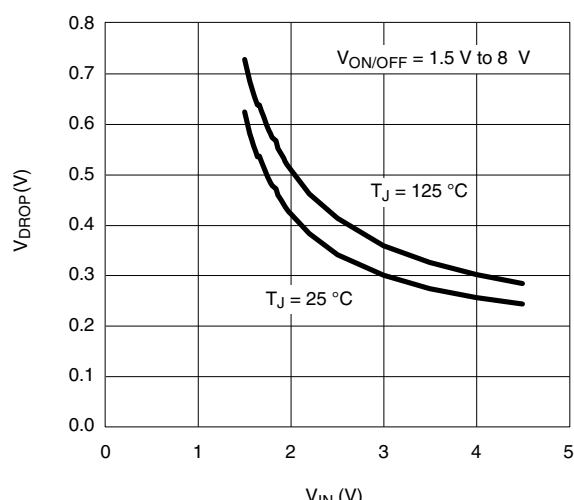
V_{DROP} vs. I_L at $V_{IN} = 4.5$ V



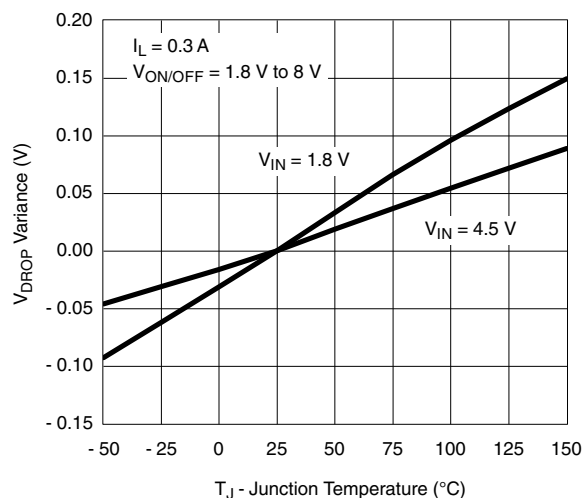
V_{DROP} vs. I_L at $V_{IN} = 2.5$ V



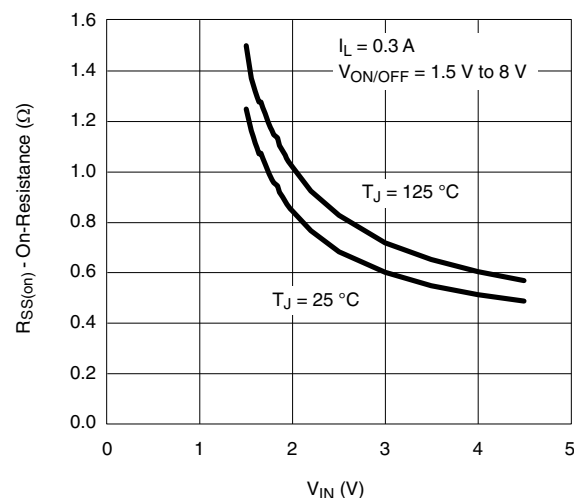
V_{DROP} vs. I_L at $V_{IN} = 1.8$ V



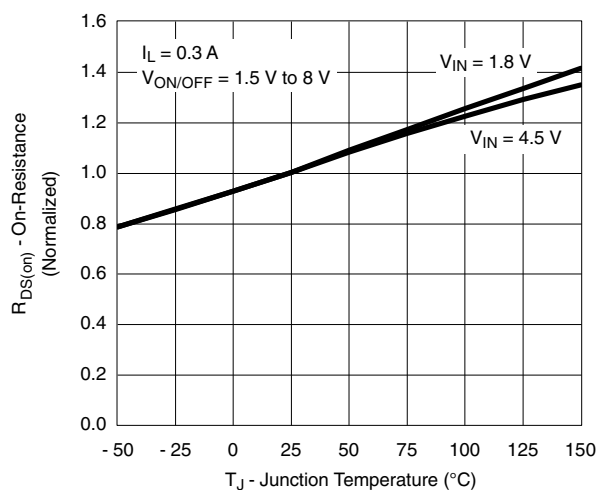
V_{DROP} vs. I_L at $V_{IN} = 0.5$ V



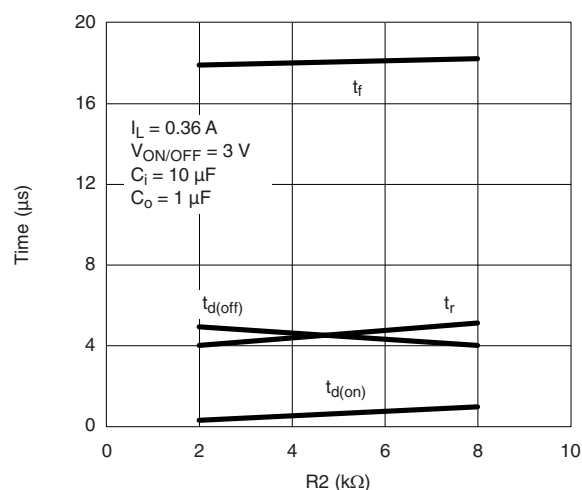
V_{DROP} Variance vs. Junction Temperature



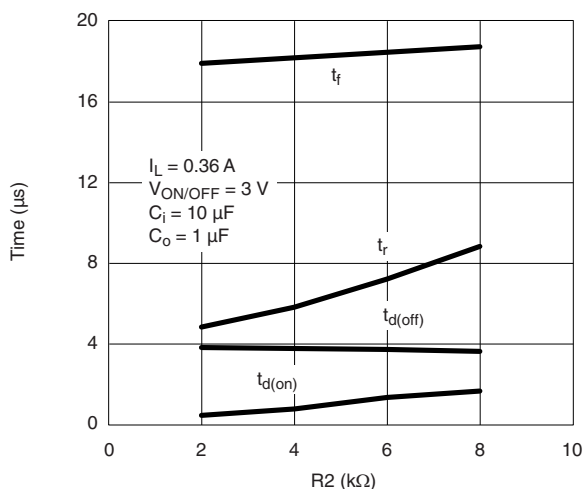
On-Resistance vs. Input Voltage

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

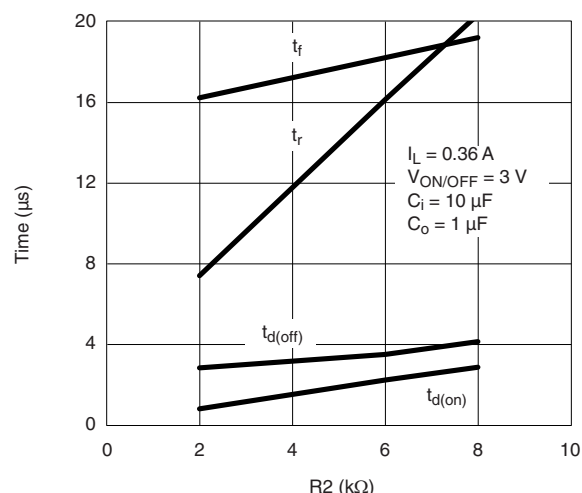
**Normalized On-Resistance
vs. Junction Temperature**



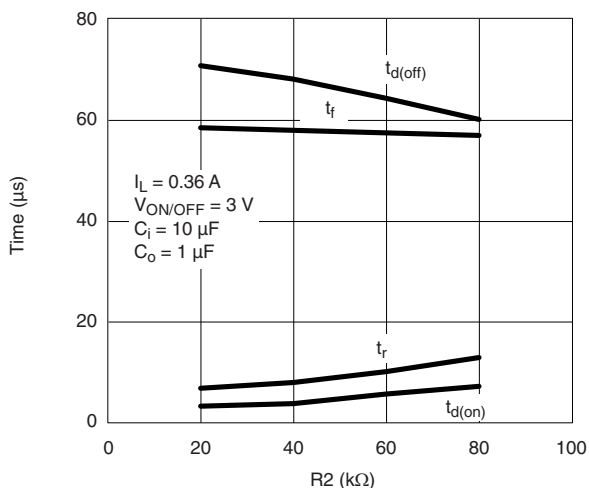
**Switching Variation
R2 at $V_{IN} = 4.5$ V, $R_1 = 20$ k Ω**



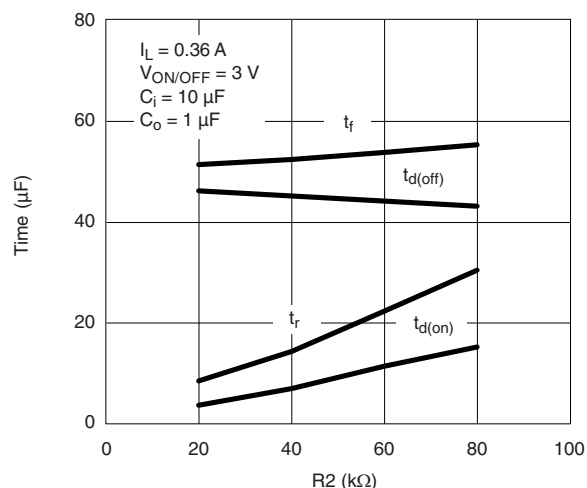
**Switching Variation
R2 at $V_{IN} = 2.5$ V, $R_1 = 20$ k Ω**



**Switching Variation
R2 at $V_{IN} = 1.8$ V, $R_1 = 20$ k Ω**

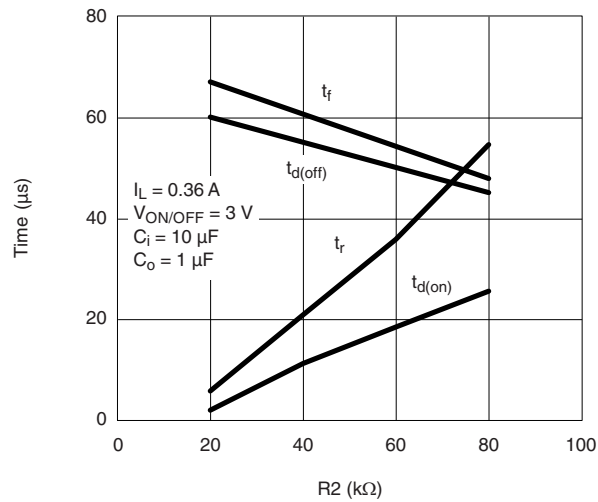


**Switching Variation
R2 at $V_{IN} = 4.5$ V, $R_1 = 300$ k Ω**

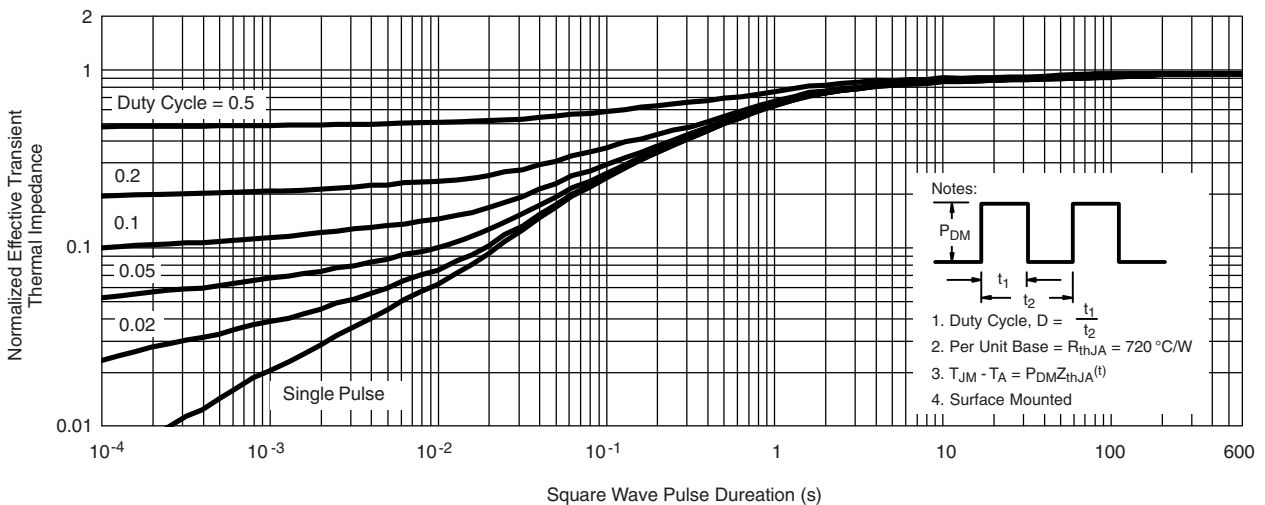


**Switching Variation
R2 at $V_{IN} = 2.5$ V, $R_1 = 300$ k Ω**

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



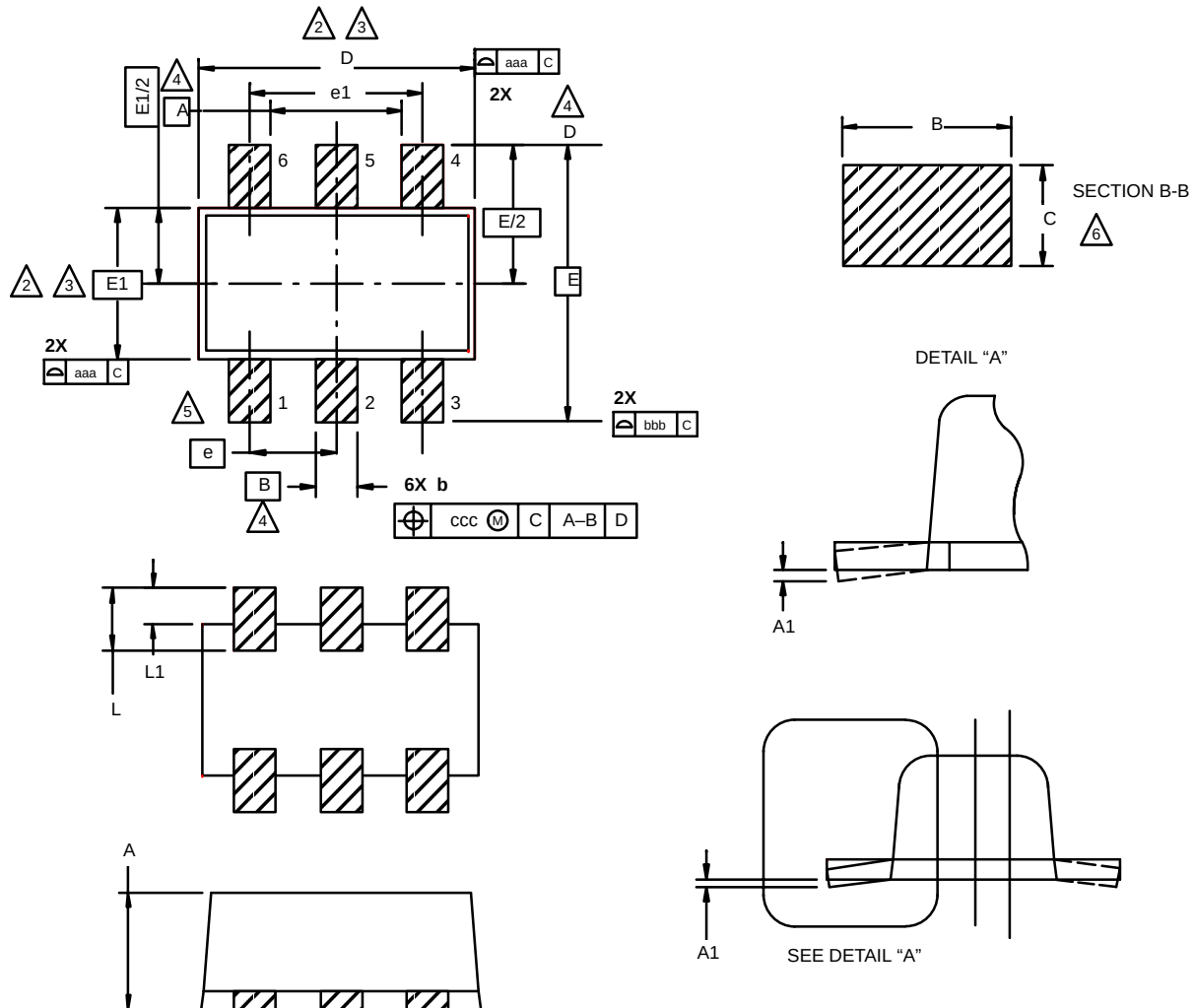
Switching Variation
 $R2 \text{ at } V_{\text{IN}} = 1.8 \text{ V}, R1 = 300 \text{ k}\Omega$



Normalized Thermal Transient Impedance, Junction-to-Ambient

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SC89: 6- LEADS (SOT-563F)



NOTES:

1. Dimensions in millimeters.

2 Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.

3 Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

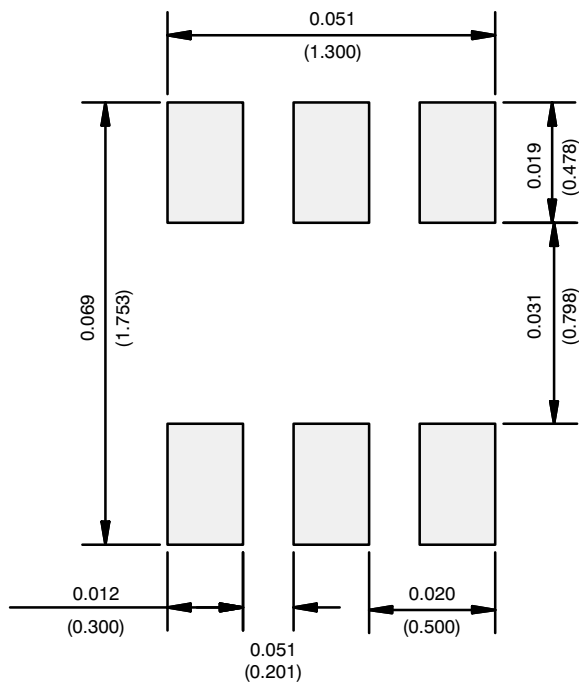
4 Datums A, B and D to be determined 0.10 mm from the lead tip.

5 Terminal numbers are shown for reference only.

6 These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

	MILLIMETERS		Note	Symbol	Tolerances Of Form And Position
Dim	Min	Max			
A	0.56	0.60		aaa	0.10
A1	0.00	0.10		bbb	0.10
b	0.15	0.30		ccc	0.10
c	0.10	0.18			
D	1.50	1.70	2, 3		
E	1.55	1.70			
E1	1.20 BSC		2, 3		
e	0.50 BSC				
e1	1.00 BSC				
L	0.35 BSC				
L1	0.20 BSC				
ECN: E-00499—Rev. B, 02-Jul-01 DWG: 5880					

RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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